



Chip Card & Security

SLE 76C1440P

296 kBytes User-ROM

144 kBytes E²PROM

8 kBytes RAM

16-bit security controller optimized for
mobile communication applications
in 0.13 μm CMOS technology

Short Product Information 10.08

This document contains preliminary information on a new product under development. Details are subject to change without notice.

Revision History: Current Version 10.08

Previous Releases:

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Important:

Further information is confidential and on request. Please contact:
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Infineon Technologies is an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives world-wide (see address list).

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16-bit security controller optimized for mobile communication applications with enhanced instruction set for large memories in 0.13 μm CMOS technology, 296 kBytes ROM, 8 kBytes RAM and 144 kBytes E²PROM

General Features

- 16-bit microcomputer in 0.13 μm CMOS technology with 24-bit linear addressing
- Highly efficient instruction set based on an 80251 type architecture
- Up to 16 Mbytes linear address space
- 44 bytes register file with 11 double word, 16 word and 16 byte registers
- **Defined migration path from SLE 66C(L)xxxPE products with minimized customer effort based on an adapted tool set**
- Dedicated, 80251-based architecture implementation with an execution time faster than a standard 80251
- **296 kBytes User-ROM**
- **144 kBytes E²PROM** with full E²PROM functionality and free partitioning between code and data
- **8 kBytes RAM**
- **1 kByte unified cache** for code and data
- **External Clock frequency 1 up to 10 MHz**
- **Internal Clock** with up to 33 MHz:
Programmable internal frequency (PLL x1...x8 and free running mode).
- **Adjustable internal frequency according to available power or required performance**
 - Increased internal frequency for maximum performance
 - Internal frequency is automatically adjusted to keep a given power limit
- Two 16-bit Autoreload Timers and Watch Dog Timer
- Power-saving sleep mode
- **Enhanced UART for handling serial interface** in accordance with ISO/IEC 7816 part 3 **supporting transmission protocols T=1 and T=0 (support of clock division factor of 8)**
- Improved CRC module with loadable initialization vector (developed according to ISO/IEC 3309 supporting CCIT v.41 & HDLC X25)
- Supply voltage range: 1.62 V to 5.5 V

- Support of current consumption limits required by GSM applications
 - < 10 mA @ 5.5 V
 - < 6 mA @ 3.3 V
 - < 4 mA @ 1.98 V
- Operating temperature range: -25 to +85°C
- Storing temperature range: - 40° to +125°C
- ESD protection larger than 4 kV (HBM)

E²PROM Technology

- Typical programming time (erase & write) = 2.3 ms without firmware
- Fast personalization mode = 1 ms per page without firmware
- Flexible page mode for 1 to 128 bytes write/erase operation for the whole NVM size
- 32 bits security area (PROM)
- Minimum of 500.000 write/erase cycles @ 25°C per page
- Typical data retention of 10 years @ 25°C
- E²PROM programming voltage generated on chip

Security features tailored for mobile communication applications

- Light sensor
- Special Function Register (SFR) encryption
- User mode Security Life Control (UmSLC)
- Pseudo Random Number Generator (PRNG)
- Interrupt and Peripheral Event Channel Controller (ITP)
 - Interrupt module for I/O interface and peripherals
 - Enabling fast data transfer through peripheral event channels (PEC)
- Watchdog Timer (WDT) incl. check point register for runtime check
- Address and data scrambling of memories

Anti Snooping

- Basic countermeasures against side-channel attacks
- Dedicated smart card controller micro-architecture

Memory Security

- **Memory Management and Protection Unit (MMU)**
 - Addressable memory up to 16 MBytes
 - Code execution from RAM possible
- 32 bits security PROM
- Unique chip identification number for each chip
- MED – memory encryption/decryption device for RAM, ROM, and NVM in code or data areas

Document References

- Confidential Hardware and Programmer Reference Manual
- Chip qualification report
- Chip delivery specification for wafer with chip-layout (die size, orientation, step size)
- Module specification containing description of package
- Module qualification report

Development Tools Overview

- Software Development Kit, SDK 70 (based on the Keil PK251 kit)
- FPGA based emulator ET70
- Worldwide application engineer team & customer dedicated Field Application Engineers
- Regular customer trainings on hardware & software tools
- On-site trainings available on request

Supported Standards

- ISO/IEC 7816
- GSM 11.11, 11.12, 11.18
- ETSI TS 102 221

Ordering Information

Type	Package ¹	Voltage Range	Temperature Range	Frequency Range (ext. clock frequency)
SLE 76C1440P C	Die (sawn, unsawn)	1.62 V - 5.5 V	- 25°C to + 85°C	1 MHz - 10 MHz
SLE 76C1440P MXXX	M5.X MFCX.X			

Flash initialization/personalization available upon request.

For ordering information please refer to the Hardware Reference Manual and contact your sales representative.

Pin Description & Module

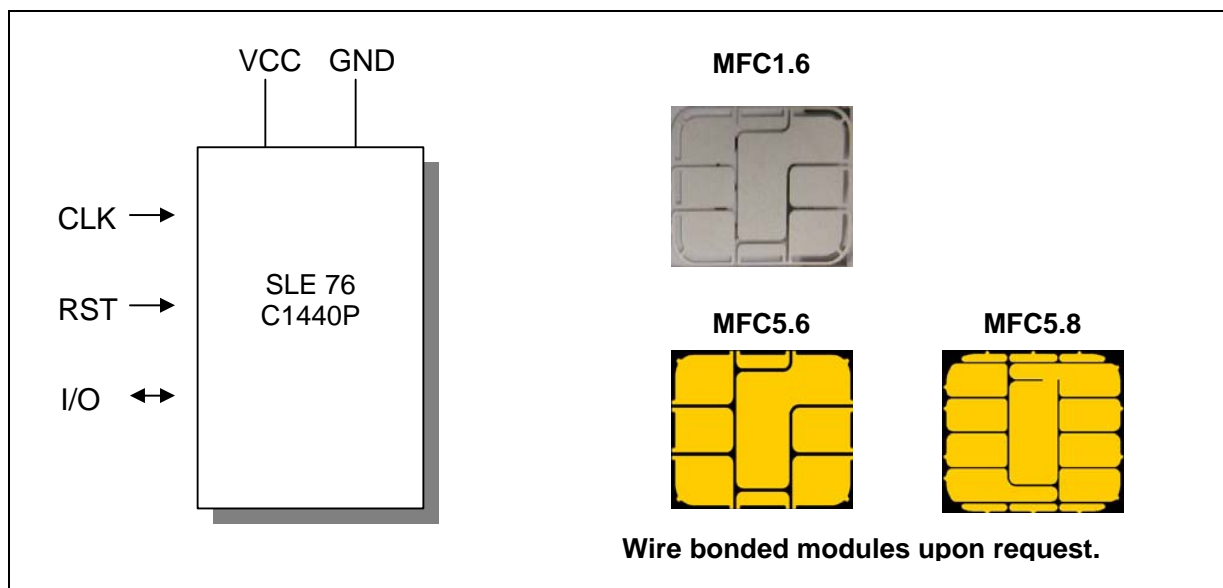


Figure 1: Pin Configuration

Pin Definitions and Functions

Symbol	Function
VCC	Operating voltage
RST	Reset input
CLK	Processor clock input
GND	Ground
I/O	Bi-directional data port

¹ available as flip chip module (MFC), wire-bonded module (M5) or as die (C) for customer packaging

General Description

The SLE 76C1440P is a member of the streamlined SLE 76P-series of Infineon Technologies optimized for mobile communication applications. This security controller is manufactured in advanced 0.13 μm CMOS technology. It has a defined migration path from existing SLE 66C(L)xxxPE products with minimized customer effort to migrate the OS and is based on the same tool set.

Performance

The internal clock frequency can be adjusted to a level of up to 33 MHz either as a multiple of 1 to 8 of the external frequency or independent of the clock rate of the terminal with the help of the internal clock. It is adjustable according to either available power requirements or required performance:

- Increased internal clock frequency for maximum performance, e.g. for high performance with max. frequency.
- Automatically adjusted frequency to keep a given maximum power consumption, for GSM requirements.

Peripherals

The Interrupt and Peripheral Event Channel Controller (ITP) can process interrupt requests from different sources to run an interrupt service routine (ISR). Data can be directly transferred between memory locations with a minimum of CPU activity for fast interaction with peripherals using so-called Peripheral Event Channels (PECs). The channels can be assigned individually to peripherals or chained together to enable continuous transfer without handover delay between the channels.

The enhanced CRC module allows the easy generation of checksums according to ISO/IEC 3309 (16-Bit-CRC) and offers a loadable initialization vector for a better Java support.

To minimize the overall power consumption, the chip card controller IC offers a sleep mode.

The improved UART supports the half-duplex transmission protocols T=0 and T=1 according to ISO/IEC 7816-3 as well as a larger FIFO and a clock division factor of 8. All relevant transmission parameters can be adjusted by software, as e.g. the clock division factor, direct/inverse convention and the number of stop bits. Additionally, the I/O port can be driven by communication routines realized in software.

The pseudo random number generator (PRNG) is able to supply random numbers.

The watchdog timer (WDT) is a circuit that monitors controller operation by automatically initiating a security reset if a specified period without an adequate response elapses after occurrence of a hardware or software irregularity.

In conclusion, the SLE 76C1440P fulfills all requirements of today's mobile communication smart card applications. In addition, it offers a powerful platform for multi application cards based on Java.

The SLE 76C1440P integrates outstanding memory sizes and peripherals in combination with enhanced performance and optimized power consumption on a minimized die size.

Memory

The SLE 76C1440P offers 300 kBytes of User-ROM, 8 kBytes RAM and 144 kBytes E²PROM to fulfill the increased requirements of mobile communication applications and allows to include SIM Application Toolkit, Wireless Application Protocol (WAP), WML-Browser and JavaCard API implementations.

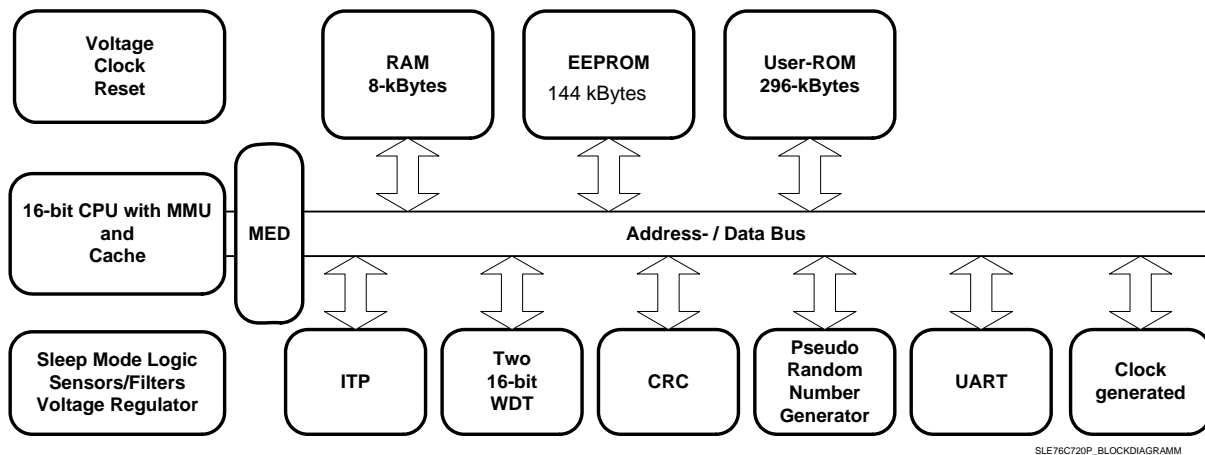


Figure 1: Block Diagram SLE 76C1440P

The new platform is designed to address up to 16 Mbytes of memory.

Security

The set of security features has been tailored to fit the requirements of mobile communication applications purposes combined with enhanced reliability for these applications.

- Encrypted storage of any confidential code, data and keys is supported.
- Basic protection against side channel attacks such as: Simple Power Analysis (SPA), Differential Power Analysis (DPA).
- Basic protection against Differential Fault Analysis (DFA) / Fault Induction Attacks.
- A customer specific transport key combined with a unique loader concept secures the logistic flow until card issuing.

Glossary

CLK	Clock
CRC	Cyclic Redundancy Check
CPU	Central Processing Unit
CMOS	Complementary Metal-Oxide Semiconductor (technology used to manufacture most of today's chips)
E ² PROM	Electrically Erasable Programmable Read-Only Memory (equivalent to NVM)
ESD	Electrostatic Discharge, release of static electricity that can damage a chip
ETSI	European Telecommunication Standards Institute
FIFO	First In, First Out
FPGA	Field Programmable Gate Array
GND	Ground
GSM	Global System for Mobile Communication
HBM	Human Body Model
ISO/IEC	International Organization for Standardization/International Electrotechnical Commission
ITP	Interrupt and Peripheral event channel controller
MED	Memory Encryption Decryption unit
MMU	Memory Management Unit
NVM	Non Volatile Memory
OS	Operating System
OTP	One Time Programmable
PEC	Peripheral Event Channel
PROM	Programmable Read-Only Memory
PRNG	Pseudo Random Number Generator
RAM	Random Access Memory
RMS	Resource Management System
ROM	Read-Only Memory
RST	Reset
SCP	Symmetric Crypto Processor
SDK CC	Software Development Kit Chip Card
T=0, T=1	Communication Protocols defined in ISO 7816 standard
UART	Universal Asynchronous Receiver/Transmitter
Vcc	External Voltage (common-collector voltage)
PLL	Phase-Locked Loop
WDT	Watch Dog Timer

Sales code name

